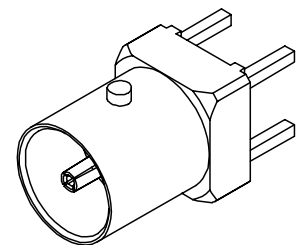


MATERIALS AND FINISHES

BODY BRASS
PLATED SEE TABLE

CENTER CONTACT BERYLLIUM COPPER
PLATED GOLD

INSULATOR TEFLON



MINI BNC JACK
INTERFACE

RECOMMENDED
PCB LAYOUT

PS-89675-3500	INTERFACE
SPECIFICATION	DESCRIPTION

73171-2732	73171-2730, ONE PER BAG
73171-2731	GOLD/BULK
73171-2730	NICKEL/BULK
PART NO.	PLATING/PACKAGING

CHG: ADDED DIMS 3.71, Ø 1.37, AND Ø 9.02 REF EC NO: URF2008-0278 2007/11/20 DRAWN: JWEENER 2007/11/20 CHKD: SSSHAH 2007/11/20 APPR: JWEENER 2007/11/20 REV DESCRIPTION A2	QUALITY SYMBOLS ▽=0 ◇=0	GENERAL TOLERANCES (UNLESS SPECIFIED)	DIMENSION STYLE		SCALE	DESIGN UNITS	THIRD ANGLE PROJECTION	TITLE	SHEET NO. 1 OF 1		
			MM/IN			METRIC					
				mm	INCH	DRAWN BY JM	DATE 2005/11/14			MINI BNC JACK, STRAIGHT PCB, 75 OHMS EWR-2951, MINI BNC-J/PCB	
			4 PLACES	± ---	± ---	CHECKED BY	DATE				
			3 PLACES	± ---	± ---	JM	2005/11/14				
			2 PLACES	± ---	± ---	APPROVED BY	DATE				
			1 PLACE	± ---	± ---	JDW	2005/11/14				
			ANGULAR ± 2 °								
			DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		SEE TABLE		DOCUMENT NO. SD-73171-273				
					SIZE C		THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION				